#### 查询SN54LVTH16501供应商

## 速多邦, 专业SAB4推VTH16501加SN74LVTH16501 3.3-VABT 18-BIT UNIVERSAL BUS TRANSCEIVERS WITH 3-STATE OUTPUTS

SN54LVTH16501 . . . WD PACKAGE

SN74LVTH16501 ... DGG OR DL PACKAGE

(TOP VIEW)

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- Members of the Texas Instruments *Widebus™* Family
- State-of-the-Art Advanced BiCMOS Technology (ABT) Design for 3.3-V Operation and Low Static-Power Dissipation
- Support Mixed-Mode Signal Operation (5-V Input and Output Voltages With 3.3-V V<sub>CC</sub>)
- Support Unregulated Battery Operation Down to 2.7 V
- UBT<sup>™</sup> (Universal Bus Transceiver) Combines D-Type Latches and D-Type Flip-Flops for Operation in Transparent, Latched, or Clocked Mode
- Typical V<sub>OLP</sub> (Output Ground Bounce) < 0.8 V at V<sub>CC</sub> = 3.3 V, T<sub>A</sub> = 25°C
- I<sub>off</sub> and Power-Up 3-State Support Hot Insertion
- Bus Hold on Data Inputs Eliminates the Need for External Pullup/Pulldown Resistors
- Distributed V<sub>CC</sub> and GND Pin Configuration Minimizes High-Speed Switching Noise
- Flow-Through Architecture Optimizes PCB
  Layout
- Latch-Up Performance Exceeds 500 mA Per JESD 17
- ESD Protection Exceeds 2000 V Per MIL-STD-883, Method 3015; Exceeds 200 V Using Machine Model (C = 200 pF, R = 0)
- Package Options Include Plastic Shrink Small-Outline (DL) and Thin Shrink
   Small-Outline (DGG) Packages and 380-mil Fine-Pitch Ceramic Flat (WD) Package Using 25-mil Center-to-Center Spacings

#### description

The 'LVTH16501 devices are 18-bit universal bus transceivers designed for low-voltage (3.3-V) V<sub>CC</sub> operation, but with the capability to provide a TTL interface to a 5-V system environment.

Data flow in each direction is controlled by output-enable (OEAB and OEBA), latch-enable (LEAB and LEBA), and clock (CLKAB and CLKBA) inputs. For A-to-B data flow, the devices operate in the transparent mode when LEAB is high. When LEAB is low, the A data is latched if CLKAB is held at a high or low logic level. If LEAB is low, the A data is stored in the latch/flip-flop on the low-to-high transition of CLKAB. When OEAB is high, the outputs are active. When OEAB is low, the outputs are in the high-impedance state.



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|                 | (101 |    |                   |
|-----------------|------|----|-------------------|
|                 |      |    | TE HEADY          |
| OEAB            |      |    | GND               |
| LEAB            |      |    | CLKAB             |
| A1              |      |    | B1                |
| GND             |      |    | GND               |
| A2              |      |    | ] B2              |
| A3              |      |    | ] B3              |
| V <sub>CC</sub> | 7    | 50 | ] V <sub>CC</sub> |
| A4              |      | 49 | ] B4              |
| A5              | 9    | 48 | ] B5              |
| A6              | 10   | 47 | ] B6              |
| GND             | 11   | 46 | ] GND             |
| A7              | 12   |    | ] B7              |
| A8              | 13   | 44 | ] B8              |
| A9              | 14   | 43 | ] B9              |
| A10             | 15   | 42 | ] B10             |
| A11             | 16   | 41 | ] B11             |
| A12             | 17   | 40 | ] B12             |
| GND             | 18   | 39 | ] GND             |
| A13             | 19   | 38 | ] B13             |
| A14             | 20   | 37 | ] B14             |
| A15             | 21   | 36 | ] B15             |
| V <sub>CC</sub> | 22   | 35 | ] V <sub>CC</sub> |
| A16             |      |    | B16               |
| A17             | 24   | 33 | ] B17             |
| GND             | 25   | 32 | ] GND             |
| A18             |      |    | ] B18             |
|                 | 27   |    | ] CLKBA           |
| LEBA            | 28   | 29 | ] GND             |



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#### description (continued)

Data flow for B to A is similar to that of A to B but uses OEBA, LEBA, and CLKBA. The output enables are complementary (OEAB is active high and OEBA is active low).

Active bus-hold circuitry is provided to hold unused or floating data inputs at a valid logic level.

When  $V_{CC}$  is between 0 and 1.5 V, the devices are in the high-impedance state during power up or power down. However, to ensure the high-impedance state above 1.5 V,  $\overline{OE}$  should be tied to  $V_{CC}$  through a pullup resistor and OE should be tied to GND through a pulldown resistor; the minimum value of the resistor is determined by the current-sinking/current-sourcing capability of the driver.

These devices are fully specified for hot-insertion applications using I<sub>off</sub> and power-up 3-state. The I<sub>off</sub> circuitry disables the outputs, preventing damaging current backflow through the devices when they are powered down. The power-up 3-state circuitry places the outputs in the high-impedance state during power up and power down, which prevents driver conflict.

The SN54LVTH16501 is characterized for operation over the full military temperature range of  $-55^{\circ}$ C to  $125^{\circ}$ C. The SN74LVTH16501 is characterized for operation from  $-40^{\circ}$ C to  $85^{\circ}$ C.

| T ONOTION TABLE! |      |            |   |                                      |  |  |  |  |  |  |
|------------------|------|------------|---|--------------------------------------|--|--|--|--|--|--|
|                  | INP  | UTS        |   | OUTPUT                               |  |  |  |  |  |  |
| OEAB             | LEAB | CLKAB      | Α | В                                    |  |  |  |  |  |  |
| L                | Х    | Х          | Х | Z                                    |  |  |  |  |  |  |
| н                | Н    | Х          | L | L                                    |  |  |  |  |  |  |
| н                | Н    | Х          | Н | н                                    |  |  |  |  |  |  |
| н                | L    | =          | L | L                                    |  |  |  |  |  |  |
| н                | L    | $\uparrow$ | н | н                                    |  |  |  |  |  |  |
| н                | L    | Н          | Х | в <sub>0</sub> ‡                     |  |  |  |  |  |  |
| н                | L    | L          | Х | в <sub>0</sub> ‡<br>в <sub>0</sub> § |  |  |  |  |  |  |
| +                |      |            |   |                                      |  |  |  |  |  |  |

#### FUNCTION TABLE<sup>†</sup>

<sup>+</sup> A-to-B data flow is shown: B-to-A flow is similar but uses OEBA, LEBA, and CLKBA.

- <sup>‡</sup>Output level before the indicated steady-state input conditions were established, provided that CLKAB was high before LEAB went low
- § Output level before the indicated steady-state input conditions were established



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1 EN1 OEAB 55 CLKAB > 2C3 2 LEAB C3 G2 27 EN4 OEBA 30 CLKBA > 5C6 28 LEBA C6 G5 54 3 3D **B1** A1 1 1∇ 4∇ 1 6D 5 52 A2 **B2** 6 51 A3 **B**3 8 49 A4 **B4** 9 48 A5 **B5** 10 47 **B6** A6 4 12 45 A7 **B7** -13 44 **A8 B8** 4-1 14 43 A9 **B**9 15 42 A10 B10 16 41 A11 B11 17 40 A12 B12 19 38 B13 A13 ↔ 20 37 A14 B14 4 21 36 B15 A15 4 34 23 **B16** A16 24 33 A17 B17 4 31 26 A18 B18 4

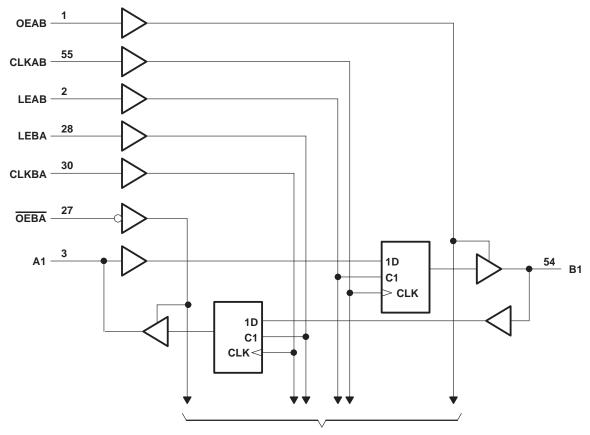
<sup>†</sup> This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

logic symbol<sup>†</sup>



#### SN54LVTH16501, SN74LVTH16501 3.3-V ABT 18-BIT UNIVERSAL BUS TRANSCEIVERS WITH 3-STATE OUTPUTS SCBS700D - JULY 1997 - REVISED APRIL 1999

## logic diagram (positive logic)



To 17 Other Channels

### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)<sup>†</sup>

| Voltage range applied to any output in the high-impedance<br>or power-off state, V <sub>O</sub> (see Note 1)  | Supply voltage range, V <sub>CC</sub><br>Input voltage range, V <sub>I</sub> (see Note 1) |   |
|---|---|---|
| $eq:state_$ |   |   |
| $\begin{array}{c} Current into any output in the low state, I_O: $N54LVTH16501$   | or power-off state, V <sub>O</sub> (see Note 1)   | $\dots \dots \dots \dots -0.5$ V to 7 V |
| $\begin{array}{c} \text{SN74LVTH16501} & 128 \text{ mA} \\ \text{Current into any output in the high state, I}_O (see Note 2): \\ \text{SN54LVTH16501} & 48 \text{ mA} \\ \text{SN74LVTH16501} & 64 \text{ mA} \\ \text{Input clamp current, I}_{IK} (V_I < 0) & -50 \text{ mA} \\ \text{Output clamp current, I}_OK (V_O < 0) & -50 \text{ mA} \\ \text{Package thermal impedance, } \theta_{JA} (see Note 3): \\ \text{DL package} & 74^\circ\text{C/W} \\ \end{array}$   | Voltage range applied to any output in the high state, V <sub>O</sub> (see Note 1)        | –0.5 V to V <sub>CC</sub> + 0.5 V       |
| $\begin{tabular}{lllllllllllllllllllllllllllllllllll$   | Current into any output in the low state, IO: SN54LVTH16501                               | 96 mA                                   |
| $\label{eq:started} SN74LVTH16501 \dots 64 mA \\ Input clamp current, I_{IK} (V_I < 0) \dots -50 mA \\ Output clamp current, I_{OK} (V_O < 0) \dots -50 mA \\ Package thermal impedance, \theta_{JA} (see Note 3): DGG package \dots 81^\circ C/W \\ DL package \dots 74^\circ C/W \\ \end{tabular}$  | SN74LVTH16501   | 128 mA                                  |
| $ \begin{array}{llllllllllllllllllllllllllllllllllll$   | Current into any output in the high state, IO (see Note 2): SN54LVTH16501                 | 48 mA                                   |
| Output clamp current, I <sub>OK</sub> (V <sub>O</sub> < 0)  | SN74LVTH16501   | 64 mA                                   |
| Output clamp current, I <sub>OK</sub> (V <sub>O</sub> < 0)  | Input clamp current, I <sub>IK</sub> (V <sub>I</sub> < 0)                                 | –50 mA                                  |
| DL package  |   |   |
|   | Package thermal impedance, $\theta_{JA}$ (see Note 3): DGG package                        | 81°C/W                                  |
| Storage temperature range, T <sub>stg</sub> –65°C to 150°C  | DL package  |   |
|   | Storage temperature range, T <sub>stg</sub>   | –65°C to 150°C                          |

† Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.

2. This current flows only when the output is in the high state and  $V_O > V_{CC}$ . 3. The package thermal impedance is calculated in accordance with JESD 51.



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#### recommended operating conditions (see Note 4)

|                     |                                    | SN54LVTI        | H16501 | SN74LVTI | H16501 | UNIT |      |
|---------------------|------------------------------------|-----------------|--------|----------|--------|------|------|
|                     |                                    |                 | MIN    | MAX      | MIN    | MAX  | UNIT |
| VCC                 | Supply voltage                     |                 | 2.7    | 3.6      | 2.7    | 3.6  | V    |
| VIH                 | High-level input voltage           |                 | 2      | N        | 2      |      | V    |
| VIL                 | Low-level input voltage            |                 | 0.8    |          | 0.8    | V    |      |
| VI                  | Input voltage                      | 4               | 5.5    |          | 5.5    | V    |      |
| ЮН                  | High-level output current          |                 | 1      | -24      |        | -32  | mA   |
| IOL                 | Low-level output current           |                 | 200    | 48       |        | 64   | mA   |
| $\Delta t/\Delta v$ | Input transition rise or fall rate | Outputs enabled | 00     | 10       |        | 10   | ns/V |
| Δt/ΔV <sub>CC</sub> | Power-up ramp rate                 |                 | 200    |          | 200    |      | μs/V |
| TA                  | Operating free-air temperature     |                 | -55    | 125      | -40    | 85   | °C   |

NOTE 4: All unused control inputs of the device must be held at V<sub>CC</sub> or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.



### SN54LVTH16501, SN74LVTH16501 **3.3-V ABT 18-BIT UNIVERSAL BUS TRANSCEIVERS** WITH 3-STATE OUTPUTS SCBS700D - JULY 1997 - REVISED APRIL 1999

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER         |   | TEST CONDITIONS   |   |                     | 4LVTH16          | 501   | SN74                |                  |      |      |  |  |
|-------------------|---|---|---|---------------------|------------------|-------|---------------------|------------------|------|------|--|--|
| PAI               | RAMEIER   | TEST CONDITIONS   |   |                     | TYP <sup>†</sup> | MAX   | MIN                 | TYP <sup>†</sup> | MAX  | UNIT |  |  |
| VIK               |   | V <sub>CC</sub> = 2.7 V,  | lj = -18 mA   |                     |                  | -1.2  |                     |                  | -1.2 | V    |  |  |
|                   |   | $V_{CC}$ = 2.7 V to 3.6 V,  | I <sub>OH</sub> = -100 μA                               | V <sub>CC</sub> -0. | 2                |       | V <sub>CC</sub> -0. | 2                |      |      |  |  |
| Varia             |   | V <sub>CC</sub> = 2.7 V,  | I <sub>OH</sub> =8 mA                                   | 2.4                 | ii               |       | 2.4                 |                  |      | v    |  |  |
| VOH               |   | V <sub>CC</sub> = 3 V   | I <sub>OH</sub> = -24 mA                                | 2                   |                  |       |                     |                  |      | v    |  |  |
|                   |   | VCC = 3 V   | I <sub>OH</sub> = -32 mA                                |                     |                  |       | 2                   |                  |      |      |  |  |
|                   |   |   | I <sub>OL</sub> = 100 μA                                |                     |                  | 0.2   |                     |                  | 0.2  |      |  |  |
|                   |   | $V_{CC} = 2.7 V$  | I <sub>OL</sub> = 24 mA                                 |                     |                  | 0.5   |                     |                  | 0.5  |      |  |  |
| Va                |   |   | I <sub>OL</sub> = 16 mA                                 |                     |                  | 0.4   |                     |                  | 0.4  | v    |  |  |
| VOL               |   |   | I <sub>OL</sub> = 32 mA                                 |                     |                  | 0.5   | 0.5                 |                  |      | v    |  |  |
|                   |   | V <sub>CC</sub> = 3 V   | I <sub>OL</sub> = 48 mA                                 |                     |                  | 0.55  |                     |                  |      |      |  |  |
|                   |   |   | I <sub>OL</sub> = 64 mA                                 |                     |                  |       |                     |                  | 0.55 |      |  |  |
| Control inputs    | Control inputo  | V <sub>CC</sub> = 3.6 V,  | $V_I = V_{CC} \text{ or } GND$                          |                     |                  | 🗴 ±1  |                     |                  | ±1   |      |  |  |
|                   | Control inputs  | V <sub>CC</sub> = 0 or 3.6 V,   | r 3.6 V, VI = 5.5 V                                     |                     |                  |       |                     |                  | 10   |      |  |  |
|                   | A or B ports‡   | V <sub>CC</sub> = 3.6 V   | V <sub>I</sub> = 5.5 V                                  |                     | R.               | 20    |                     |                  | 20   | μΑ   |  |  |
|                   |   |   | $V_I = V_{CC}$  |                     | 1                |       |                     | 1                |      |      |  |  |
|                   |   |   | V <sub>I</sub> = 0                                      |                     | 2                | -5    |                     |                  | -5   | 1    |  |  |
| loff              | •   | V <sub>CC</sub> = 0,  | $V_{I} \text{ or } V_{O} = 0 \text{ to } 4.5 \text{ V}$ | C                   | ) (              |       |                     |                  | ±100 | μΑ   |  |  |
|                   |   | N 2.V   | V <sub>I</sub> = 0.8 V                                  | 75                  |                  |       | 75                  |                  |      |      |  |  |
| II(hold)          | A or B ports  | V <sub>CC</sub> = 3 V   | -75   |                     |                  | -75   |                     |                  | μA   |      |  |  |
| . ,               |   | V <sub>CC</sub> = 3.6 V§,   | V <sub>I</sub> = 0 to 3.6 V                             |                     |                  |       |                     |                  | ±500 |      |  |  |
| IOZPU             | -   | $\frac{V_{CC}}{OE/OE} = 0$ to 1.5 V, V <sub>O</sub> = OE/OE = don't care                                    | 0.5 V to 3 V,   |                     |                  | ±100* |                     |                  | ±100 | μA   |  |  |
| IOZPD             | IOZPD $\frac{V_{CC}}{OE/OE} = 1.5 \text{ V to } 0, \text{ V}_{O} = 0$ |   | 0.5 V to 3 V,   |                     |                  | ±100* |                     |                  | ±100 | μA   |  |  |
|                   |   | V <sub>CC</sub> = 3.6 V,  | Outputs high  |                     |                  | 0.19  |                     |                  | 0.19 |      |  |  |
| ICC               | $V_{CC} = 3.6 V,$<br>$I_{O} = 0,$                                     | Outputs low   |   |                     | 5                |       |                     | 5                | mA   |      |  |  |
|                   |   | $V_{I} = V_{CC}$ or GND   | Outputs disabled  | 0.19                |                  |       | 0.19                |                  |      |      |  |  |
| $\Delta I_{CC}$ ¶ |   | $V_{CC} = 3 \text{ V}$ to 3.6 V, One input at $V_{CC} - 0.6 \text{ V}$ ,<br>Other inputs at $V_{CC}$ or GND |   |                     |                  | 0.2   |                     |                  | 0.2  | mA   |  |  |
| Ci                |   | V <sub>I</sub> = 3 V or 0   |   |                     | 4                |       |                     | 4                |      | pF   |  |  |
| Cio               |   | $V_{O} = 3 V \text{ or } 0$   |   |                     | 10               |       |                     | 10               |      | pF   |  |  |

\* On products compliant to MIL-PRF-38535, this parameter is not production tested.

† All typical values are at  $V_{CC}$  = 3.3 V,  $T_A$  = 25°C. ‡ Unused pins at  $V_{CC}$  or GND

§ This is the bus-hold maximum dynamic current. It is the minimum overdrive current required to switch the input from one state to another.  $\P$  This is the increase in supply current for each input that is at the specified TTL voltage level rather than V<sub>CC</sub> or GND.



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# timing requirements over recommended operating free-air temperature range (unless otherwise noted) (see Figure 1)

|                               |                                    |                  |                            | 5   | SN54LVTH16501           |     |                                    | SN74LVTH16501 |                         |     |      |     |  |
|-------------------------------|------------------------------------|------------------|----------------------------|-----|-------------------------|-----|------------------------------------|---------------|-------------------------|-----|------|-----|--|
|                               |                                    |                  | V <sub>CC</sub> =<br>± 0.: |     | V <sub>CC</sub> = 2.7 V |     | V <sub>CC</sub> = 3.3 V<br>± 0.3 V |               | V <sub>CC</sub> = 2.7 V |     | UNIT |     |  |
|                               |                                    |                  |                            | MIN | MAX                     | MIN | MAX                                | MIN           | MAX                     | MIN | MAX  |     |  |
| fclock                        | f <sub>clock</sub> Clock frequency |                  |                            |     | 150                     |     | 150                                |               | 150                     |     | 150  | MHz |  |
| t <sub>w</sub> Pulse duration |                                    | LE high          |                            | 3.3 |                         | 3.3 |                                    | 3.3           |                         | 3.3 |      | ns  |  |
| tw                            | Fuise duration                     | CLK high or low  |                            | 3.3 |                         | 3.3 |                                    | 3.3           |                         | 3.3 |      | 115 |  |
|                               |                                    | A before CLKAB↑  |                            | 2.3 |                         | 2.6 |                                    | 2.1           |                         | 2.4 |      |     |  |
|                               | Catura time a                      | B before CLKBA↑  |                            | 2.3 | 4                       | 2.6 |                                    | 2.1           |                         | 2.4 |      |     |  |
| <sup>I</sup> SU               | t <sub>su</sub> Setup time         | ·                | CLK high                   | 2.6 | NUC                     | 1.8 |                                    | 2.4           |                         | 1.6 |      | ns  |  |
|                               | A or B before LE $\downarrow$      | CLK low          | 1.6                        | 20  | 0.7                     |     | 1.4                                |               | 0.5                     |     |      |     |  |
| t liaid times                 | A or B after CLK↑                  |                  | 1.1                        | 2   | 0                       |     | 1                                  |               | 0                       |     | 20   |     |  |
| h                             | t <sub>h</sub> Hold time           | A or B after LE↓ |                            | 1.8 |                         | 1.8 |                                    | 1.7           |                         | 1.7 |      | ns  |  |

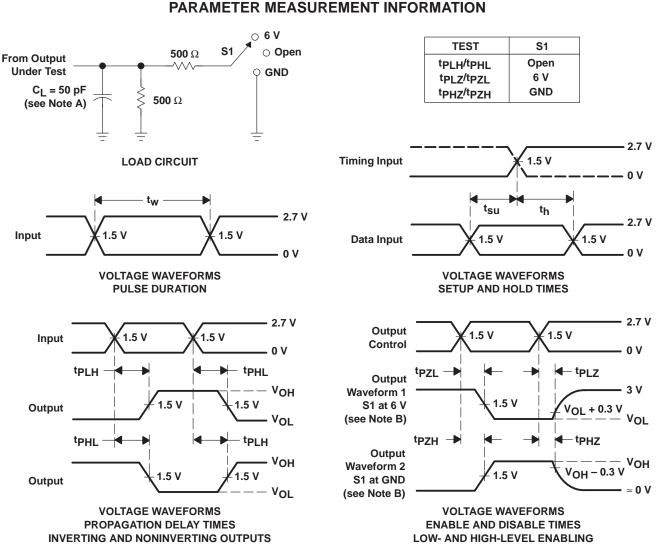
switching characteristics over recommended operating free-air temperature range,  $C_L = 50 \text{ pF}$  (unless otherwise noted) (see Figure 1)

|                  |                 | SN54LVTH16501  |  |              |           |     |                                    |      |                         |     |      |     |
|------------------|-----------------|----------------|--|--------------|-----------|-----|------------------------------------|------|-------------------------|-----|------|-----|
| PARAMETER        | FROM<br>(INPUT) | TO<br>(OUTPUT) | V <sub>CC</sub> = 3.3 V<br>± 0.3 V V <sub>CC</sub> = |              | C = 2.7 V |     | V <sub>CC</sub> = 3.3 V<br>± 0.3 V |      | / V <sub>CC</sub> = 2.7 |     | UNIT |     |
|                  |                 |                | MIN  | MAX          | MIN       | MAX | MIN                                | түр† | MAX                     | MIN | MAX  |     |
| f <sub>max</sub> |                 |                | 150  |              | 150       |     | 150                                |      |                         | 150 |      | MHz |
| <sup>t</sup> PLH | D or A          | A or B         | 1.2  | 3.9          |           | 4.3 | 1.3                                | 2.7  | 3.7                     |     | 4    | ns  |
| <sup>t</sup> PHL | B or A          | AUB            | 1.2  | 3.9          | M         | 4.3 | 1.3                                | 2.4  | 3.7                     |     | 4    | 115 |
| <sup>t</sup> PLH | LEBA or LEAB    | A or B         | 1.4  | 5.5          | N.        | 5.9 | 1.5                                | 3.4  | 5.1                     |     | 5.7  | ns  |
| <sup>t</sup> PHL | LEDA OI LEAD    | AUB            | 1.4  | 5.5          | 4         | 5.9 | 1.5                                | 3.5  | 5.1                     |     | 5.7  | 115 |
| <sup>t</sup> PLH | CLKBA or        | A or B         | 1.2  | 5.4          |           | 6   | 1.3                                | 3.5  | 5.1                     |     | 5.7  | ns  |
| <sup>t</sup> PHL | CLKAB           | AUB            | 1.2  | 5.4          |           | 6   | 1.3                                | 3.4  | 5.1                     |     | 5.7  | 115 |
| <sup>t</sup> PZH | OEBA or OEAB    | A or B         | 1.2  | 5.1          |           | 5.8 | 1.3                                | 3.4  | 4.8                     |     | 5.5  | ns  |
| <sup>t</sup> PZL |                 | AUB            | 1.2  | <b>Q</b> 5.1 |           | 5.8 | 1.3                                | 3.4  | 4.8                     |     | 5.5  | 115 |
| <sup>t</sup> PHZ | OEBA or OEAB    | A or B         | 1.6  | 6.1          |           | 6.6 | 1.7                                | 4.2  | 5.8                     |     | 6.3  | ns  |
| <sup>t</sup> PLZ | OEDA UI ÜEAD    | AUB            | 1.6  | 6.1          |           | 6.6 | 1.7                                | 3.8  | 5.8                     |     | 6.3  | 115 |

<sup>†</sup> All typical values are at V<sub>CC</sub> = 3.3 V, T<sub>A</sub> = 25°C.



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NOTES: A. CL includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  10 MHz, Z<sub>O</sub> = 50  $\Omega$ , t<sub>r</sub>  $\leq$  2.5 ns, t<sub>f</sub>  $\leq$  2.5 ns.

D. The outputs are measured one at a time with one transition per measurement.





#### **IMPORTANT NOTICE**

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